April 2013



SEMICONDUCTOR®

FDA70N20 N-Channel UniFET[™] MOSFET 200 V, 70 A, 35 mΩ

Features

- $R_{DS(on)} = 35 \text{ m}\Omega \text{ (Max.)} @ V_{GS} = 10 \text{ V}, I_D = 35 \text{ A}$
- Low Gate Charge (Typ. 66 nC)
- Low Crss (Typ. 89 pF)
- 100% avalanche Tested

Applications

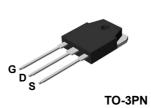
- Uninterruptible Power Supply
- AC-DC Power Supply



Description

UniFET[™] MOSFET is Fairchild Semiconductor[®]'s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.

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Absolute Maximum Ratings

Symbol	Parameter			FDA70N20	Unit	
V _{DSS}	Drain-Source Voltage			200	V	
I _D	Drain Current	ain Current - Continuous ($T_C = 25^{\circ}C$) - Continuous ($T_C = 100^{\circ}C$)		70 45	A A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	280	A	
V _{GSS}	Gate-Source voltage			±30	V	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	1742	mJ	
I _{AR}	Avalanche Current		(Note 1)	70	A	
E _{AR}	Repetitive Avalanch	e Energy	(Note 1)	41.7	mJ	
dv/dt	Peak Diode Recove	ry dv/dt	(Note 3)	4.5	V/ns	
P _D	Power Dissipation $(T_C = 25^{\circ}C)$ - Derate above $25^{\circ}C$			417 3.3	W W/°C	
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
Τ _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

Symbol	Parameter	FDA70N20	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	0.3	°C/W	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.24	°C/W	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W	

		Device	Packag	kage Reel Size Tap		e Width		Quantity	
		TO-3P	D-3PN -		-		30		
Electrica	al Char	racteristics T _c	= 25°C unless oth	erwise noted					
Symbol		Parameter		Conditio	าร	Min.	Тур.	Max	Unit
Off Charact	teristics								
BV _{DSS}	Drain-Source Breakdown Voltage		ge V _G	V _{GS} = 0V, I _D = 250μA		200			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient		e I _D =	$I_D = 250 \mu A$, Referenced to 25°C			0.2		V/°C
I _{DSS}	Zero Gate Voltage Drain Current			$V_{DS} = 200V, V_{GS} = 0V$ $V_{DS} = 160V, T_{C} = 125^{\circ}C$				1 10	μΑ μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward		orward V _G	$V_{GS} = 30V, V_{DS} = 0V$				100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse			$V_{GS} = -30V, V_{DS} = 0V$				-100	nA
On Charact	teristics								
V _{GS(th)}	Gate Threshold Voltage		V _D	V _{DS} = V _{GS} , I _D = 250μA		3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance		V _G	V _{GS} = 10V, I _D = 35A			0.029	0.035	Ω
9 _{FS}	Forward Transconductance		V _D	V _{DS} = 40V, I _D = 35A (Note 4)			47		S
Dynamic C	haracteris	tics							
C _{iss}	Input Capacitance Output Capacitance			V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz			3050	3970	pF
C _{oss}			f =				750	980	pF
C _{rss}	Reverse Transfer Capacitance						89	130	pF
Switching (Characteri	stics	•						
t _{d(on)}	Turn-On Delay Time		V _{DI}	V _{DD} = 100V, I _D = 70A			71	150	ns
t _r	Turn-On F	Rise Time	R _G	R _G = 25Ω (Note 4, 5)			235	480	ns
t _{d(off)}	Turn-Off [Delay Time					65	140	ns
t _f	Turn-Off F	Fall Time					39	88	ns
Qg	Total Gate	e Charge	V _D	$V_{DS} = 160V, I_{D} = 70A$ $V_{GS} = 10V$ (Note 4, 5)			66	86	nC
Q _{gs}	Gate-Sou	rce Charge	V _G				19		nC
Q _{gd}	Gate-Drai	n Charge					26		nC
Drain-Sour	ce Diode (Characteristics and I	Maximum Rat	tings				I	I
I _S	S Maximum Continuous Drain-Source Dioc			de Forward Current				70	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Fo		Diode Forwa	prward Current				280	Α
V _{SD}	Drain-Sou	Irce Diode Forward Vo	oltage V _G	_S = 0V, I _S = 70A				1.4	V
t _{rr}	Reverse F	Recovery Time	V _G	_S = 0V, I _S = 70A			175		ns
Q _{rr}	Reverse F	Recovery Charge	dl _F	/dt =100Å/µs	(Note 4)		4.1		μC

NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. L = 0.533mH, I_{AS} = 70A, V_DD = 50V, R_G = 25 Ω , Starting T_J = 25°C

3. $I_{SD} \leq$ 70A, di/dt \leq 200A/µs, $V_{DD} \leq BV_{DSS},$ Starting T_J = 25°C

4. Pulse Test: Pulse width $\leq 300 \mu s,$ Duty Cycle $\leq 2\%$

5. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

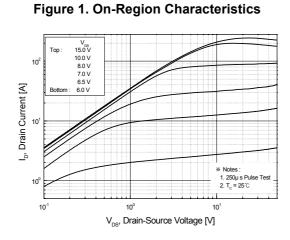


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

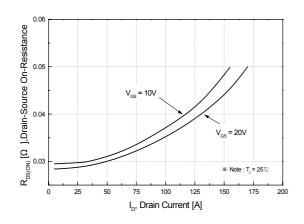


Figure 5. Capacitance Characteristics

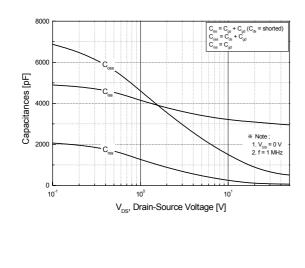


Figure 2. Transfer Characteristics

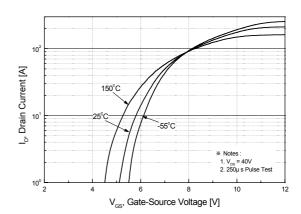
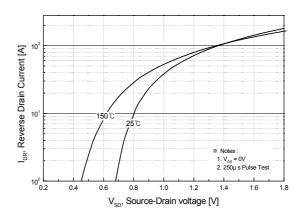
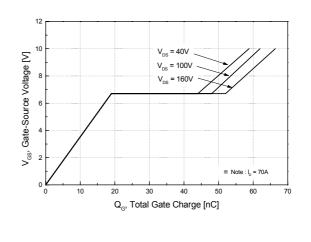


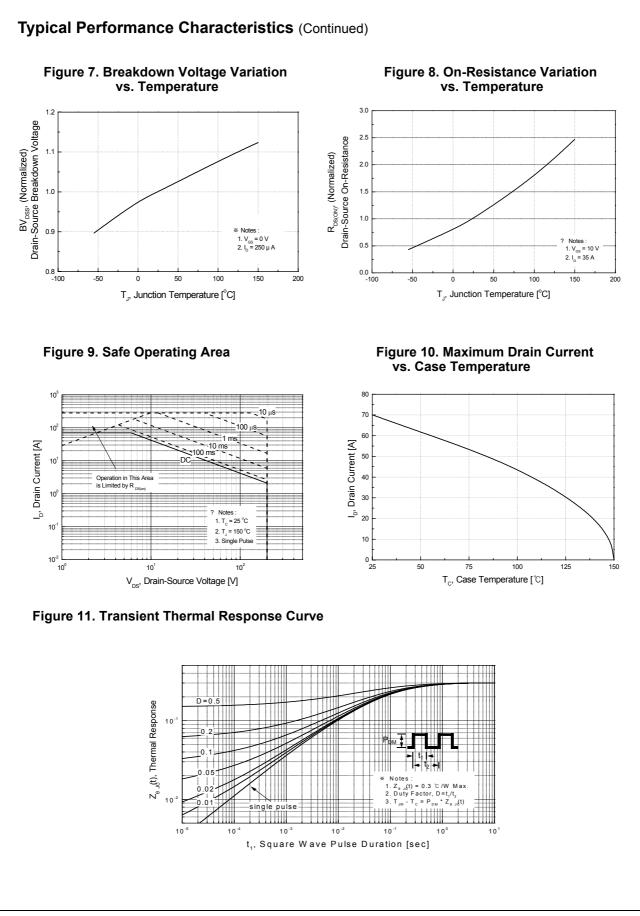
Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperatue



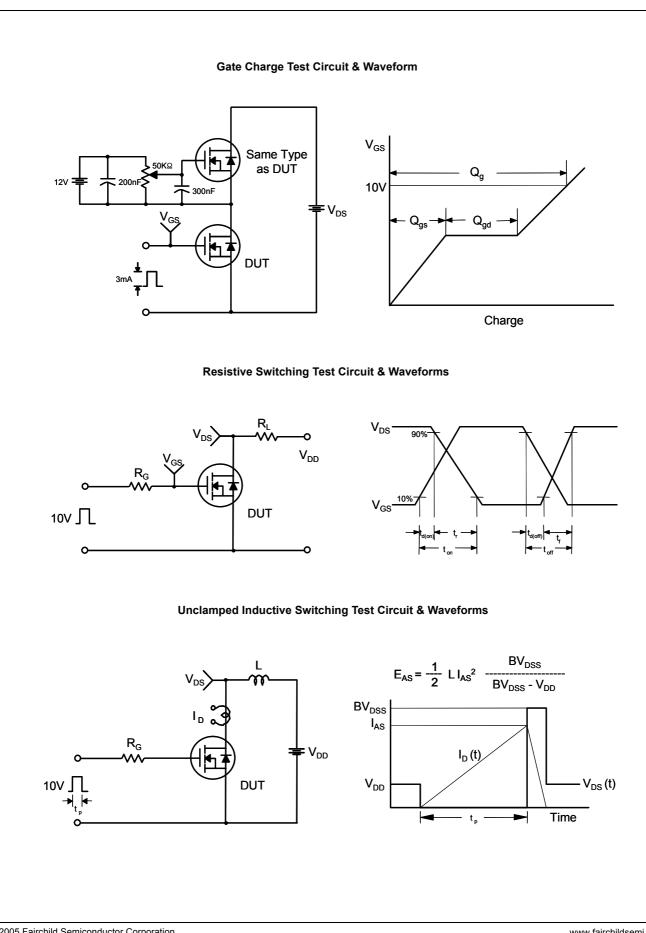




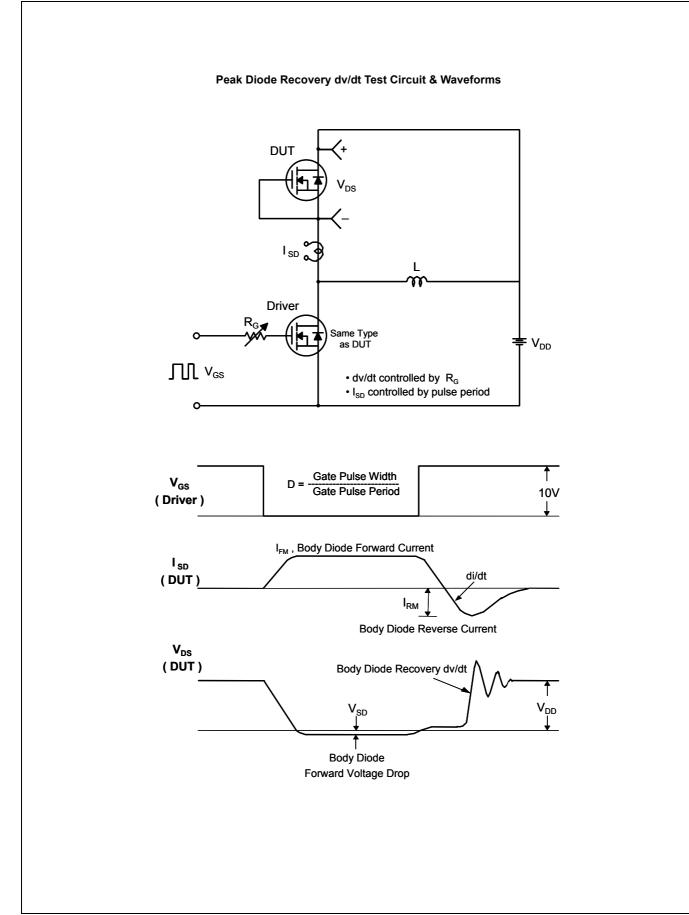
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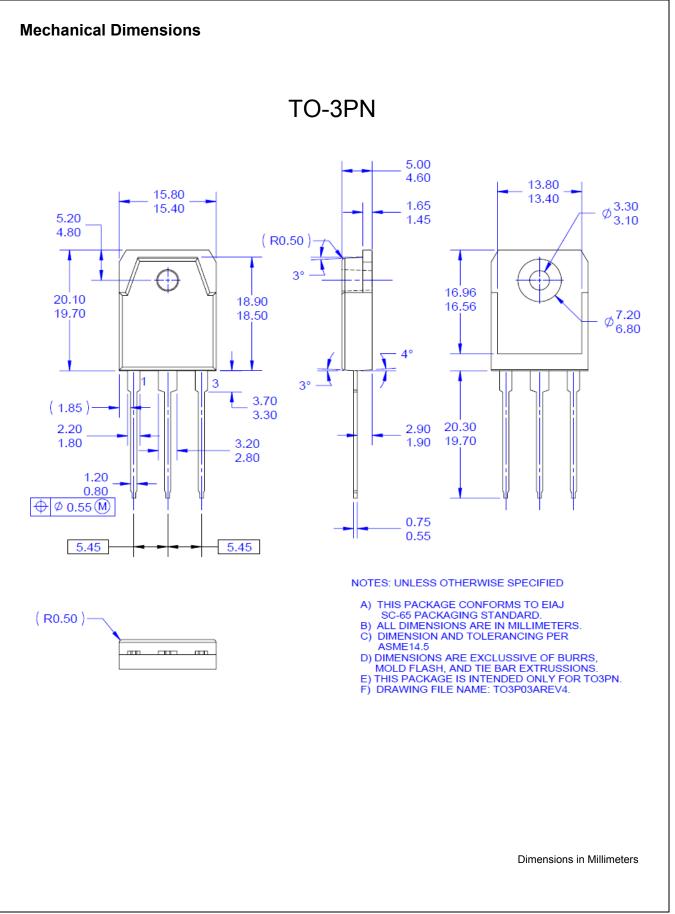
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FDA70N20 N-Channel UniFETTM MOSFET



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